



## 7 GB/s Through 4 Channels

Phison PS5025-E25 (E25) is a cutting-edge SSD controller IC solution designed to take full advantage of the PCIe Gen4x4 bandwidth. With a 4-channel design capable of powering NAND flash data transfers at 2400MT/s, the E25 touches the interface ceiling with over 7GB/s in SSD sequential operation while maintaining superior cost-effectiveness and power-efficiency, making it the perfect solution for premium laptops and mobile devices.

### Applications

High-end Desktop and Laptop



## Product Features

### Market-leading Performance

Paired with state-of-the-art 3D NAND flash memory chips, the E25 handles application payloads immaculately at up to 2400 MT/s with minimal latency, boasting sequential performances up to 7200 MB/s and random performance up to 1200K IOPs.

### Superb Power Efficiency

Through its 4-channel design and LPDDR compatibility, the E25 offers serious reduction in power consumption versus competing solutions. With advanced power management measures such as support of the PS0 (under 8.25mW) and PS4 (under 3.5mW) power states, the E25 is able to further limit motherboard power consumption during idle periods.

### Outstanding Cost-effectiveness

The E25 saturates the PCIe Gen4x4 interface bandwidth as well as any 8-channel solution does, but it does so while retaining compelling cost-savings in silicon, creating invaluable design-in opportunities in cost-sensitive consumer markets.

### Extensive Compliance

The E25 solution portfolio has undergone various certification programs and compliance verifications from industry giants like Intel, AMD, Microsoft, as well as renowned third-party institutions such as the PCI-SIG. Let Phison E25 connect you to the world and create the synergy you need.

# CONTROLLER

## PS5025-E25

| Features          | Specifications  |
|-------------------|---|
| Host Interface    | <ul style="list-style-type: none"><li>- PCIe 4.0x4 (Bandwidth: 16GT/s x4)</li><li>- Backward compatible with existing PCIe generation transfer rates</li><li>- Compliance with PCI Express Base Specification Revision 4.0</li><li>- Compliance with NVMe 2.0</li></ul>   |
| Processor         | <ul style="list-style-type: none"><li>- Dual-CPU architecture with built-in 32-bit microcontroller</li><li>- TSMC 12nm process technology</li></ul>   |
| Flash Controller  | <ul style="list-style-type: none"><li>- Up to 4 Channels with 16 Chips Enable (CE) counts</li><li>- Flash transfer rate up to 2,400MT/s</li><li>- Capacity up to 4TB</li><li>- Support 3D TLC and QLC NAND flash memory</li><li>- Compliance with Toggle 5.0 and ONFi 5.0</li><li>- Flash I/O operating voltage supply 1.2V</li></ul> |
| DRAM Controller   | <ul style="list-style-type: none"><li>- LPDDR4/DDR4 (32 bit, 2666Mbps)</li></ul>  |
| Data Reliability  | <ul style="list-style-type: none"><li>- Phison 5th generation LDPC ECC &amp; RAID ECC</li><li>- DDR ECC engine</li><li>- End-To-End Data Path Protection</li></ul>  |
| Security          | <ul style="list-style-type: none"><li>- Pyrite</li><li>- AES 256</li><li>- SHA 512</li><li>- RSA 4096</li><li>- TCG Opal 2.02</li></ul>   |
| Performance       | <ul style="list-style-type: none"><li>- Sequential Read up to 7200MB/s</li><li>- Sequential Write up to 7000MB/s</li><li>- 4K Random Read up to 1200K IOPS</li><li>- 4K Random Write up to 1200K IOPS</li></ul>   |
| Power Management  | <ul style="list-style-type: none"><li>- L1.2 &lt; 3.5mW</li></ul>   |
| Temperature Range | <ul style="list-style-type: none"><li>- Operating range: 0~70 °C</li><li>- Storage range: -40~85 °C</li></ul>   |
| Package           | <ul style="list-style-type: none"><li>- 361-ball HSFCCSP, 12.5mm x 12.5mm</li></ul>   |
| Peripheral        | <ul style="list-style-type: none"><li>- Built-in internal thermal sensor</li><li>- GPIO pins</li><li>- Built-in UART function</li><li>- I2C and SPI for external ROM</li></ul>  |



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# SOLUTIONS

## PS5025-E25

| Capacity <sup>(1)</sup>   | 512GB  | 1TB             | 2TB        | 4TB                       |
|---|--|-----------------|------------|---------------------------|
| Interface   | PCIe Gen 4.0 x4 NVMe 2.0   |                 |            |                           |
| Form Factor   | M.2 2280   |                 |            |                           |
| NAND Flash  | 3D TLC   |                 |            |                           |
| <b>Performance <sup>(2)</sup></b>   |  |                 |            |                           |
| Sequential Read   | 6850 MB/s  | 7100 MB/s       | 7100 MB/s  | 7000 MB/s <sup>(6)</sup>  |
| Sequential Write  | 4000 MB/s  | 6900 MB/s       | 7050 MB/s  | 6900 MB/s <sup>(6)</sup>  |
| 4K Random Read  | 680K IOPS  | 1050K IOPS      | 1150K IOPS | 1150K IOPS <sup>(6)</sup> |
| 4K Random Write   | 700K IOPS  | 1200K IOPS      | 1200K IOPS | 1200K IOPS <sup>(6)</sup> |
| <b>Power Consumption <sup>(3)</sup></b>   |  |                 |            |                           |
| Supply Voltage  | M.2 3.3V ± 5%  |                 |            |                           |
| Active (Average)  | < 8.25W  | < 8.25W         | < 8.25W    | < 10W <sup>(6)</sup>      |
| Idle  | < 25mW   | < 25mW          | < 25mW     | < 35mW <sup>(6)</sup>     |
| Low Power PS4 (L1.2)  | < 3.5mW  | < 3.5mW         | < 3.5mW    | < 3.5mW <sup>(6)</sup>    |
| <b>Environmental</b>  |  |                 |            |                           |
| Operating Temperature   | 0°C - 70°C   |                 |            |                           |
| Non-Operating Temperature   | -40°C - 85°C   |                 |            |                           |
| Certification   | Intel PCL, AMD AVL, PCI-SIG Certified, Microsoft Direct Storage, Windows Modern Standby, Athena Modern Standby (<3 mW), MobileMark® 2018 (<100mW), MobileMark® 2025 (<160mW) |                 |            |                           |
| <b>Reliability &amp; Warranty</b>   |  |                 |            |                           |
| TBW <sup>(5)</sup>  | 300TB  | 600TB           | 1200TB     | 1200TB                    |
| Warranty  | 5 years  |                 |            |                           |
| MTBF  | 1.5 million hours  | 2 million hours |            |                           |
| UBER  | <10 <sup>-15</sup> bits  |                 |            |                           |
| <b>Advanced Features</b>  |  |                 |            |                           |
| <ul style="list-style-type: none"> <li>- End-to-End Data Protection</li> <li>- TCG OPAL 2.02 and Crypto Erase</li> <li>- GPIO Pins, Built-in UART function and I2C feature support</li> </ul> |  |                 |            |                           |

<sup>(1)</sup> 1 GB = 1,000,000,000 bytes

<sup>(2)</sup> Sequential Performance is based on CrystalDiskMark v8, 1 GB range, command size =1MB, QD=32, Thread=1, and test drive set as secondary

<sup>(3)</sup> Random Performance is based on CrystalDiskMark v8, 1 GB range, command size =4KB, QD=32, Thread=16, and test drive set as secondary

<sup>(4)</sup> Power consumption is measured during the sequential read and write operations performed by CrystalDiskMark with the conditions described in (2)

<sup>(5)</sup> TBW is Total Bytes Written and the results are obtained in compliance with JESD218 Standards

<sup>(6)</sup> Numbers are estimated value.



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